# Multilayer Ceramic Chip Capacitors

## C1005X7R1H103M050BE



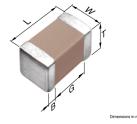






#### TDK item description C1005X7R1H103MT\*\*\*S

Applications	Commercial Grade  Please refer to Part No. CGA2B3X7R1H103M050BE for Automotive use.	
Feature	Soft Termination	
Series	C1005 [EIA 0402]	
Status	Production	



Size		
Length(L)	1.00mm +0.15,-0.05mm	
Width(W)	0.50mm +0.10,-0.05mm	
Thickness(T)	0.50mm +0.10,-0.05mm	
Terminal Width(B)	0.10mm Min.	
Terminal Spacing(G)	0.30mm Min.	
Recommended Land Pattern (PA)	0.30mm to 0.50mm	
Recommended Land Pattern (PB)	0.35mm to 0.45mm	
Recommended Land Pattern (PC)	0.40mm to 0.60mm	

Electrical Characteristics		
Capacitance	10nF ±20%	
Rated Voltage	50VDC	
Temperature Characteristic	X7R(±15%)	
Dissipation Factor (Max.)	5%	
Insulation Resistance (Min.)	10000ΜΩ	

Other		
Soldering Method	Reflow	
AEC-Q200	No	
Packing	Punched (Paper)Taping [180mm Reel]	
Package Quantity	10000pcs	

<sup>!</sup> Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

#### C1005X7R1H103M050BE

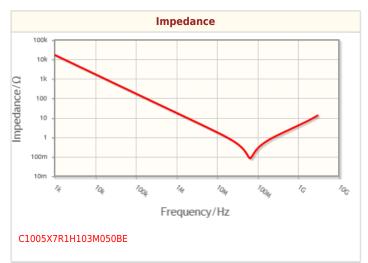


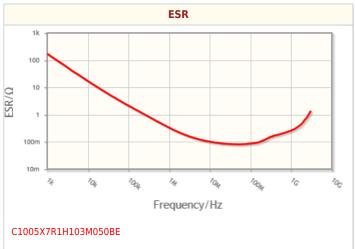


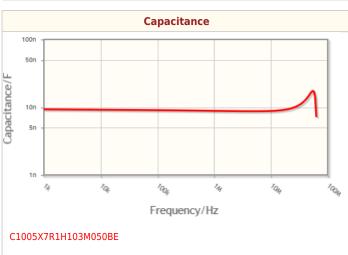


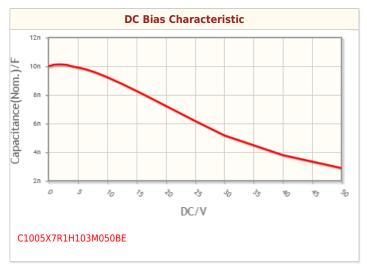


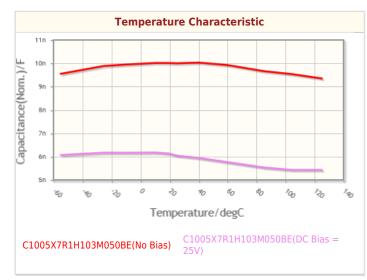
# Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

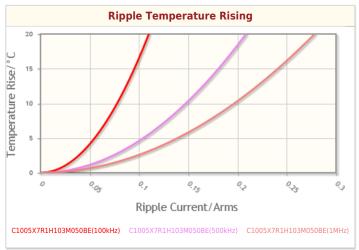












<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

## C1005X7R1H103M050BE

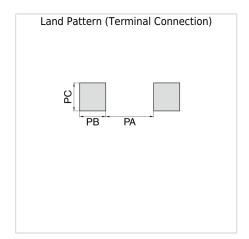








# **Associated Images**



<sup>!</sup> Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.